

# Global System-In-Package Market Professional Survey Report 2017

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### **Abstracts**

This report studies System-In-Package in Global market, especially in North America, China, Europe, Southeast Asia, Japan and India, with production, revenue, consumption, import and export in these regions, from 2012 to 2016, and forecast to 2022.

This report focuses on top manufacturers in global market, with production, price, revenue and market share for each manufacturer, covering

| Amkor Technology   |
|--------------------|
| ASE                |
| JCET               |
| SPIL               |
| UTAC               |
| Chipmos Technology |
| Chipsip Technology |
| NANIUM             |
| Octavo Systems     |



### Samsung Electro-Mechanics

On the basis of product, this report displays the production, revenue, price, market share and growth rate of each type, primarily split into

| Surface Mount Technology (SMT)                                                |
|-------------------------------------------------------------------------------|
| Small Outline Package (SOP)                                                   |
| Ball Grid Array (BGA)                                                         |
| Quad Flat Package. (QFP)                                                      |
| By Application, the market can be split into                                  |
| Consumer Electronics                                                          |
| Automotive                                                                    |
| Networking                                                                    |
| Medical Electronics                                                           |
| Computing                                                                     |
| Mobile                                                                        |
| Communication                                                                 |
| By Regions, this report covers (we can add the regions/countries as you want) |
| North America                                                                 |
| China                                                                         |
| Europe                                                                        |



| Southeast Asia |  |  |  |
|----------------|--|--|--|
| Japan          |  |  |  |
| India          |  |  |  |

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#### **Contents**

Global System-In-Package Market Professional Survey Report 2017

#### 1 INDUSTRY OVERVIEW OF SYSTEM-IN-PACKAGE

- 1.1 Definition and Specifications of System-In-Package
  - 1.1.1 Definition of System-In-Package
  - 1.1.2 Specifications of System-In-Package
- 1.2 Classification of System-In-Package
  - 1.2.1 Surface Mount Technology (SMT)
  - 1.2.2 Small Outline Package (SOP)
  - 1.2.3 Ball Grid Array (BGA)
  - 1.2.4 Quad Flat Package. (QFP)
- 1.3 Applications of System-In-Package
  - 1.3.1 Consumer Electronics
  - 1.3.2 Automotive
  - 1.3.3 Networking
  - 1.3.4 Medical Electronics
  - 1.3.5 Computing
  - 1.3.6 Mobile
  - 1.3.7 Communication
- 1.4 Market Segment by Regions
  - 1.4.1 North America
  - 1.4.2 China
  - 1.4.3 Europe
  - 1.4.4 Southeast Asia
  - 1.4.5 Japan
  - 1.4.6 India

#### 2 MANUFACTURING COST STRUCTURE ANALYSIS OF SYSTEM-IN-PACKAGE

- 2.1 Raw Material and Suppliers
- 2.2 Manufacturing Cost Structure Analysis of System-In-Package
- 2.3 Manufacturing Process Analysis of System-In-Package
- 2.4 Industry Chain Structure of System-In-Package

# 3 TECHNICAL DATA AND MANUFACTURING PLANTS ANALYSIS OF SYSTEM-IN-PACKAGE



- 3.1 Capacity and Commercial Production Date of Global System-In-Package Major Manufacturers in 2016
- 3.2 Manufacturing Plants Distribution of Global System-In-Package Major Manufacturers in 2016
- 3.3 R&D Status and Technology Source of Global System-In-Package Major Manufacturers in 2016
- 3.4 Raw Materials Sources Analysis of Global System-In-Package Major Manufacturers in 2016

#### 4 GLOBAL SYSTEM-IN-PACKAGE OVERALL MARKET OVERVIEW

- 4.1 2012-2017E Overall Market Analysis
- 4.2 Capacity Analysis
  - 4.2.1 2012-2017E Global System-In-Package Capacity and Growth Rate Analysis
- 4.2.2 2016 System-In-Package Capacity Analysis (Company Segment)
- 4.3 Sales Analysis
  - 4.3.1 2012-2017E Global System-In-Package Sales and Growth Rate Analysis
  - 4.3.2 2016 System-In-Package Sales Analysis (Company Segment)
- 4.4 Sales Price Analysis
  - 4.4.1 2012-2017E Global System-In-Package Sales Price
  - 4.4.2 2016 System-In-Package Sales Price Analysis (Company Segment)

#### **5 SYSTEM-IN-PACKAGE REGIONAL MARKET ANALYSIS**

- 5.1 North America System-In-Package Market Analysis
  - 5.1.1 North America System-In-Package Market Overview
- 5.1.2 North America 2012-2017E System-In-Package Local Supply, Import, Export, Local Consumption Analysis
  - 5.1.3 North America 2012-2017E System-In-Package Sales Price Analysis
  - 5.1.4 North America 2016 System-In-Package Market Share Analysis
- 5.2 China System-In-Package Market Analysis
  - 5.2.1 China System-In-Package Market Overview
- 5.2.2 China 2012-2017E System-In-Package Local Supply, Import, Export, Local Consumption Analysis
  - 5.2.3 China 2012-2017E System-In-Package Sales Price Analysis
  - 5.2.4 China 2016 System-In-Package Market Share Analysis
- 5.3 Europe System-In-Package Market Analysis
- 5.3.1 Europe System-In-Package Market Overview



- 5.3.2 Europe 2012-2017E System-In-Package Local Supply, Import, Export, Local Consumption Analysis
  - 5.3.3 Europe 2012-2017E System-In-Package Sales Price Analysis
- 5.3.4 Europe 2016 System-In-Package Market Share Analysis
- 5.4 Southeast Asia System-In-Package Market Analysis
  - 5.4.1 Southeast Asia System-In-Package Market Overview
- 5.4.2 Southeast Asia 2012-2017E System-In-Package Local Supply, Import, Export, Local Consumption Analysis
  - 5.4.3 Southeast Asia 2012-2017E System-In-Package Sales Price Analysis
  - 5.4.4 Southeast Asia 2016 System-In-Package Market Share Analysis
- 5.5 Japan System-In-Package Market Analysis
  - 5.5.1 Japan System-In-Package Market Overview
- 5.5.2 Japan 2012-2017E System-In-Package Local Supply, Import, Export, Local Consumption Analysis
  - 5.5.3 Japan 2012-2017E System-In-Package Sales Price Analysis
- 5.5.4 Japan 2016 System-In-Package Market Share Analysis
- 5.6 India System-In-Package Market Analysis
  - 5.6.1 India System-In-Package Market Overview
- 5.6.2 India 2012-2017E System-In-Package Local Supply, Import, Export, Local Consumption Analysis
  - 5.6.3 India 2012-2017E System-In-Package Sales Price Analysis
  - 5.6.4 India 2016 System-In-Package Market Share Analysis

# 6 GLOBAL 2012-2017E SYSTEM-IN-PACKAGE SEGMENT MARKET ANALYSIS (BY TYPE)

- 6.1 Global 2012-2017E System-In-Package Sales by Type
- 6.2 Different Types of System-In-Package Product Interview Price Analysis
- 6.3 Different Types of System-In-Package Product Driving Factors Analysis
- 6.3.1 Surface Mount Technology (SMT) of System-In-Package Growth Driving Factor Analysis
- 6.3.2 Small Outline Package (SOP) of System-In-Package Growth Driving Factor Analysis
  - 6.3.3 Ball Grid Array (BGA) of System-In-Package Growth Driving Factor Analysis
- 6.3.4 Quad Flat Package. (QFP) of System-In-Package Growth Driving Factor Analysis

# 7 GLOBAL 2012-2017E SYSTEM-IN-PACKAGE SEGMENT MARKET ANALYSIS (BY APPLICATION)



- 7.1 Global 2012-2017E System-In-Package Consumption by Application
- 7.2 Different Application of System-In-Package Product Interview Price Analysis
- 7.3 Different Application of System-In-Package Product Driving Factors Analysis
- 7.3.1 Consumer Electronics of System-In-Package Growth Driving Factor Analysis
- 7.3.2 Automotive of System-In-Package Growth Driving Factor Analysis
- 7.3.3 Networking of System-In-Package Growth Driving Factor Analysis
- 7.3.4 Medical Electronics of System-In-Package Growth Driving Factor Analysis
- 7.3.5 Computing of System-In-Package Growth Driving Factor Analysis
- 7.3.6 Mobile of System-In-Package Growth Driving Factor Analysis
- 7.3.7 Communication of System-In-Package Growth Driving Factor Analysis

#### 8 MAJOR MANUFACTURERS ANALYSIS OF SYSTEM-IN-PACKAGE

- 8.1 Amkor Technology
  - 8.1.1 Company Profile
  - 8.1.2 Product Picture and Specifications
    - 8.1.2.1 Product A
    - 8.1.2.2 Product B
- 8.1.3 Amkor Technology 2016 System-In-Package Sales, Ex-factory Price, Revenue, Gross Margin Analysis
- 8.1.4 Amkor Technology 2016 System-In-Package Business Region Distribution Analysis
- 8.2 ASE
  - 8.2.1 Company Profile
  - 8.2.2 Product Picture and Specifications
    - 8.2.2.1 Product A
    - 8.2.2.2 Product B
- 8.2.3 ASE 2016 System-In-Package Sales, Ex-factory Price, Revenue, Gross Margin Analysis
  - 8.2.4 ASE 2016 System-In-Package Business Region Distribution Analysis
- **8.3 JCET** 
  - 8.3.1 Company Profile
  - 8.3.2 Product Picture and Specifications
    - 8.3.2.1 Product A
    - 8.3.2.2 Product B
- 8.3.3 JCET 2016 System-In-Package Sales, Ex-factory Price, Revenue, Gross Margin Analysis
  - 8.3.4 JCET 2016 System-In-Package Business Region Distribution Analysis



- **8.4 SPIL** 
  - 8.4.1 Company Profile
  - 8.4.2 Product Picture and Specifications
    - 8.4.2.1 Product A
    - 8.4.2.2 Product B
- 8.4.3 SPIL 2016 System-In-Package Sales, Ex-factory Price, Revenue, Gross Margin Analysis
- 8.4.4 SPIL 2016 System-In-Package Business Region Distribution Analysis
- 8.5 UTAC
  - 8.5.1 Company Profile
  - 8.5.2 Product Picture and Specifications
    - 8.5.2.1 Product A
    - 8.5.2.2 Product B
- 8.5.3 UTAC 2016 System-In-Package Sales, Ex-factory Price, Revenue, Gross Margin Analysis
  - 8.5.4 UTAC 2016 System-In-Package Business Region Distribution Analysis
- 8.6 Chipmos Technology
  - 8.6.1 Company Profile
  - 8.6.2 Product Picture and Specifications
    - 8.6.2.1 Product A
    - 8.6.2.2 Product B
- 8.6.3 Chipmos Technology 2016 System-In-Package Sales, Ex-factory Price,

Revenue, Gross Margin Analysis

- 8.6.4 Chipmos Technology 2016 System-In-Package Business Region Distribution Analysis
- 8.7 Chipsip Technology
  - 8.7.1 Company Profile
  - 8.7.2 Product Picture and Specifications
    - 8.7.2.1 Product A
    - 8.7.2.2 Product B
- 8.7.3 Chipsip Technology 2016 System-In-Package Sales, Ex-factory Price, Revenue, Gross Margin Analysis
- 8.7.4 Chipsip Technology 2016 System-In-Package Business Region Distribution Analysis
- 8.8 NANIUM
  - 8.8.1 Company Profile
  - 8.8.2 Product Picture and Specifications
    - 8.8.2.1 Product A
    - 8.8.2.2 Product B



- 8.8.3 NANIUM 2016 System-In-Package Sales, Ex-factory Price, Revenue, Gross Margin Analysis
- 8.8.4 NANIUM 2016 System-In-Package Business Region Distribution Analysis
- 8.9 Octavo Systems
  - 8.9.1 Company Profile
  - 8.9.2 Product Picture and Specifications
    - 8.9.2.1 Product A
    - 8.9.2.2 Product B
- 8.9.3 Octavo Systems 2016 System-In-Package Sales, Ex-factory Price, Revenue, Gross Margin Analysis
- 8.9.4 Octavo Systems 2016 System-In-Package Business Region Distribution Analysis
- 8.10 Samsung Electro-Mechanics
  - 8.10.1 Company Profile
  - 8.10.2 Product Picture and Specifications
    - 8.10.2.1 Product A
    - 8.10.2.2 Product B
- 8.10.3 Samsung Electro-Mechanics 2016 System-In-Package Sales, Ex-factory Price, Revenue, Gross Margin Analysis
- 8.10.4 Samsung Electro-Mechanics 2016 System-In-Package Business Region Distribution Analysis

#### 9 DEVELOPMENT TREND OF ANALYSIS OF SYSTEM-IN-PACKAGE MARKET

- 9.1 Global System-In-Package Market Trend Analysis
  - 9.1.1 Global 2017-2022 System-In-Package Market Size (Volume and Value) Forecast
  - 9.1.2 Global 2017-2022 System-In-Package Sales Price Forecast
- 9.2 System-In-Package Regional Market Trend
  - 9.2.1 North America 2017-2022 System-In-Package Consumption Forecast
  - 9.2.2 China 2017-2022 System-In-Package Consumption Forecast
  - 9.2.3 Europe 2017-2022 System-In-Package Consumption Forecast
  - 9.2.4 Southeast Asia 2017-2022 System-In-Package Consumption Forecast
  - 9.2.5 Japan 2017-2022 System-In-Package Consumption Forecast
  - 9.2.6 India 2017-2022 System-In-Package Consumption Forecast
- 9.3 System-In-Package Market Trend (Product Type)
- 9.4 System-In-Package Market Trend (Application)

#### 10 SYSTEM-IN-PACKAGE MARKETING TYPE ANALYSIS

10.1 System-In-Package Regional Marketing Type Analysis



- 10.2 System-In-Package International Trade Type Analysis
- 10.3 Traders or Distributors with Contact Information of System-In-Package by Region
- 10.4 System-In-Package Supply Chain Analysis

#### 11 CONSUMERS ANALYSIS OF SYSTEM-IN-PACKAGE

- 11.1 Consumer 1 Analysis
- 11.2 Consumer 2 Analysis
- 11.3 Consumer 3 Analysis
- 11.4 Consumer 4 Analysis

# 12 CONCLUSION OF THE GLOBAL SYSTEM-IN-PACKAGE MARKET PROFESSIONAL SURVEY REPORT 2017

Methodology Analyst Introduction Data Source

The report requires updating with new data and is sent in 2-3 business days after order is placed.



### **List Of Tables**

#### LIST OF TABLES AND FIGURES

Figure Picture of System-In-Package

Table Product Specifications of System-In-Package

Table Classification of System-In-Package

Figure Global Production Market Share of System-In-Package by Type in 2016

Figure Surface Mount Technology (SMT) Picture

Table Major Manufacturers of Surface Mount Technology (SMT)

Figure Small Outline Package (SOP) Picture

Table Major Manufacturers of Small Outline Package (SOP)

Figure Ball Grid Array (BGA) Picture

Table Major Manufacturers of Ball Grid Array (BGA)

Figure Quad Flat Package. (QFP) Picture

Table Major Manufacturers of Quad Flat Package. (QFP)

Table Applications of System-In-Package

Figure Global Consumption Volume Market Share of System-In-Package by Application in 2016

Figure Consumer Electronics Examples

Table Major Consumers in Consumer Electronics

Figure Automotive Examples

Table Major Consumers in Automotive

Figure Networking Examples

Table Major Consumers in Networking

Figure Medical Electronics Examples

Table Major Consumers in Medical Electronics

Figure Computing Examples

Table Major Consumers in Computing

Figure Mobile Examples

Table Major Consumers in Mobile

Figure Communication Examples

Table Major Consumers in Communication

Figure Market Share of System-In-Package by Regions

Figure North America System-In-Package Market Size (Million USD) (2012-2022)

Figure China System-In-Package Market Size (Million USD) (2012-2022)

Figure Europe System-In-Package Market Size (Million USD) (2012-2022)

Figure Southeast Asia System-In-Package Market Size (Million USD) (2012-2022)

Figure Japan System-In-Package Market Size (Million USD) (2012-2022)



Figure India System-In-Package Market Size (Million USD) (2012-2022)

Table System-In-Package Raw Material and Suppliers

Table Manufacturing Cost Structure Analysis of System-In-Package in 2016

Figure Manufacturing Process Analysis of System-In-Package

Figure Industry Chain Structure of System-In-Package

Table Capacity and Commercial Production Date of Global System-In-Package Major Manufacturers in 2016

Table Manufacturing Plants Distribution of Global System-In-Package Major Manufacturers in 2016

Table R&D Status and Technology Source of Global System-In-Package Major Manufacturers in 2016

Table Raw Materials Sources Analysis of Global System-In-Package Major Manufacturers in 2016

Table Global Capacity, Sales, Price, Cost, Sales Revenue (M USD) and Gross Margin of System-In-Package 2012-2017

Figure Global 2012-2017E System-In-Package Market Size (Volume) and Growth Rate

Figure Global 2012-2017E System-In-Package Market Size (Value) and Growth Rate

Table 2012-2017E Global System-In-Package Capacity and Growth Rate

Table 2016 Global System-In-Package Capacity (K Units) List (Company Segment)

Table 2012-2017E Global System-In-Package Sales (K Units) and Growth Rate

Table 2016 Global System-In-Package Sales (K Units) List (Company Segment)

Table 2012-2017E Global System-In-Package Sales Price (USD/Unit)

Table 2016 Global System-In-Package Sales Price (USD/Unit) List (Company Segment)

Figure North America Capacity Overview

Table North America Supply, Import, Export and Consumption (K Units) of System-In-Package 2012-2017E

Figure North America 2012-2017E System-In-Package Sales Price (USD/Unit)

Figure North America 2016 System-In-Package Sales Market Share

Figure China Capacity Overview

Table China Supply, Import, Export and Consumption (K Units) of System-In-Package 2012-2017E

Figure China 2012-2017E System-In-Package Sales Price (USD/Unit)

Figure China 2016 System-In-Package Sales Market Share

Figure Europe Capacity Overview

Table Europe Supply, Import, Export and Consumption (K Units) of System-In-Package 2012-2017E

Figure Europe 2012-2017E System-In-Package Sales Price (USD/Unit)

Figure Europe 2016 System-In-Package Sales Market Share

Figure Southeast Asia Capacity Overview



Table Southeast Asia Supply, Import, Export and Consumption (K Units) of System-In-Package 2012-2017E

Figure Southeast Asia 2012-2017E System-In-Package Sales Price (USD/Unit)

Figure Southeast Asia 2016 System-In-Package Sales Market Share

Figure Japan Capacity Overview

Table Japan Supply, Import, Export and Consumption (K Units) of System-In-Package 2012-2017E

Figure Japan 2012-2017E System-In-Package Sales Price (USD/Unit)

Figure Japan 2016 System-In-Package Sales Market Share

Figure India Capacity Overview

Table India Supply, Import, Export and Consumption (K Units) of System-In-Package 2012-2017E

Figure India 2012-2017E System-In-Package Sales Price (USD/Unit)

Figure India 2016 System-In-Package Sales Market Share

Table Global 2012-2017E System-In-Package Sales (K Units) by Type

Table Different Types System-In-Package Product Interview Price

Table Global 2012-2017E System-In-Package Sales (K Units) by Application

Table Different Application System-In-Package Product Interview Price

Table Amkor Technology Information List

**Table Product A Overview** 

Table Product B Overview

Table 2016 Amkor Technology System-In-Package Revenue (Million USD), Sales (K Units), Ex-factory Price (USD/Unit)

Figure 2016 Amkor Technology System-In-Package Business Region Distribution

Table ASE Information List

**Table Product A Overview** 

Table Product B Overview

Table 2016 ASE System-In-Package Revenue (Million USD), Sales (K Units), Exfactory Price (USD/Unit)

Figure 2016 ASE System-In-Package Business Region Distribution

Table JCET Information List

**Table Product A Overview** 

Table Product B Overview

Table 2015 JCET System-In-Package Revenue (Million USD), Sales (K Units), Exfactory Price (USD/Unit)

Figure 2016 JCET System-In-Package Business Region Distribution

Table SPIL Information List

**Table Product A Overview** 

Table Product B Overview



Table 2016 SPIL System-In-Package Revenue (Million USD), Sales (K Units), Exfactory Price (USD/Unit)

Figure 2016 SPIL System-In-Package Business Region Distribution

**Table UTAC Information List** 

**Table Product A Overview** 

Table Product B Overview

Table 2016 UTAC System-In-Package Revenue (Million USD), Sales (K Units), Exfactory Price (USD/Unit)

Figure 2016 UTAC System-In-Package Business Region Distribution

Table Chipmos Technology Information List

**Table Product A Overview** 

Table Product B Overview

Table 2016 Chipmos Technology System-In-Package Revenue (Million USD), Sales (K Units), Ex-factory Price (USD/Unit)

Figure 2016 Chipmos Technology System-In-Package Business Region Distribution

Table Chipsip Technology Information List

Table Product A Overview

Table Product B Overview

Table 2016 Chipsip Technology System-In-Package Revenue (Million USD), Sales (K Units), Ex-factory Price (USD/Unit)

Figure 2016 Chipsip Technology System-In-Package Business Region Distribution

**Table NANIUM Information List** 

**Table Product A Overview** 

**Table Product B Overview** 

Table 2016 NANIUM System-In-Package Revenue (Million USD), Sales (K Units), Exfactory Price (USD/Unit)

Figure 2016 NANIUM System-In-Package Business Region Distribution

Table Octavo Systems Information List

**Table Product A Overview** 

Table Product B Overview

Table 2016 Octavo Systems System-In-Package Revenue (Million USD), Sales (K Units), Ex-factory Price (USD/Unit)

Figure 2016 Octavo Systems System-In-Package Business Region Distribution

Table Samsung Electro-Mechanics Information List

**Table Product A Overview** 

Table Product B Overview

Table 2016 Samsung Electro-Mechanics System-In-Package Revenue (Million USD),

Sales (K Units), Ex-factory Price (USD/Unit)

Figure 2016 Samsung Electro-Mechanics System-In-Package Business Region



#### Distribution

Figure Global 2017-2022 System-In-Package Market Size (K Units) and Growth Rate Forecast

Figure Global 2017-2022 System-In-Package Market Size (Million USD) and Growth Rate Forecast

Figure Global 2017-2022 System-In-Package Sales Price (USD/Unit) Forecast Figure North America 2017-2022 System-In-Package Consumption Volume (K Units) and Growth Rate Forecast

Figure China 2017-2022 System-In-Package Consumption Volume (K Units) and Growth Rate Forecast

Figure Europe 2017-2022 System-In-Package Consumption Volume (K Units) and Growth Rate Forecast

Figure Southeast Asia 2017-2022 System-In-Package Consumption Volume (K Units) and Growth Rate Forecast

Figure Japan 2017-2022 System-In-Package Consumption Volume (K Units) and Growth Rate Forecast

Figure India 2017-2022 System-In-Package Consumption Volume (K Units) and Growth Rate Forecast

Table Global Sales Volume (K Units) of System-In-Package by Type 2017-2022
Table Global Consumption Volume (K Units) of System-In-Package by Application 2017-2022

Table Traders or Distributors with Contact Information of System-In-Package by Region



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